

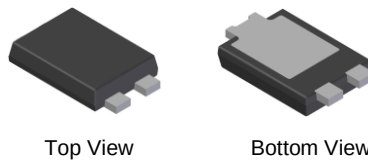
Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for +200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology (SBR®)
- High Forward Surge Capability
- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- An Automotive-Compliant Part is Available Under Separate Datasheet ([SBR10U45SP5Q](#))**

Mechanical Data

- Case: PowerDI® 5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.093 grams (Approximate)

PowerDI5



LEFT PIN  RIGHT PIN   **BOTTOMSIDE
HEAT SINK**

**Note: Pins Left & Right must
be electrically connected
at the printed circuit board.**

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR10U45SP5-13	PowerDI5	5,000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

PowerDI5



S10U45S = Product Type Marking Code
DII = Manufacturer's Code Marking
K = Factory Designator
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 17 for 2017)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	V
RMS Reverse Voltage	V _{R(RMS)}	32	V
Average Rectified Output Current	I _O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	275	A
Repetitive Peak Avalanche Power (1μs, +25°C)	P _{ARM}	30,000	W

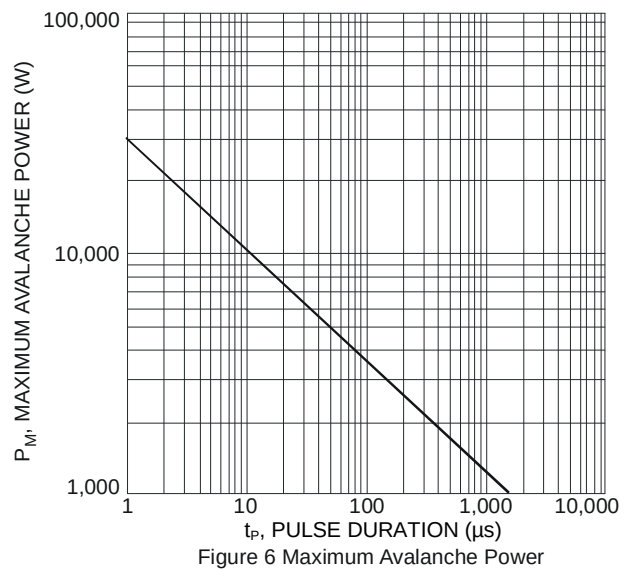
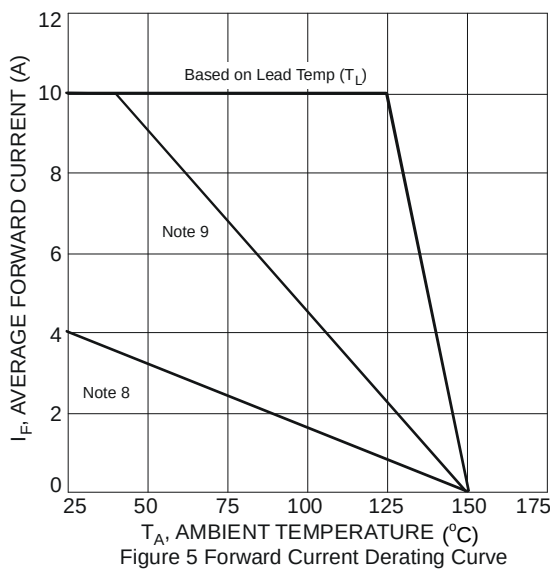
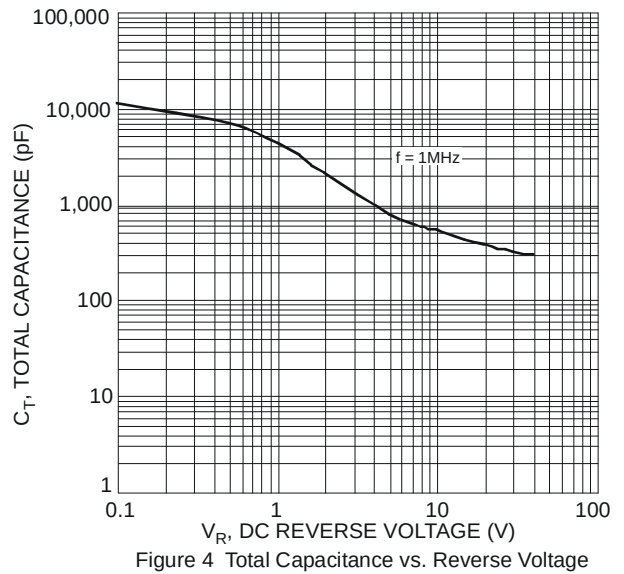
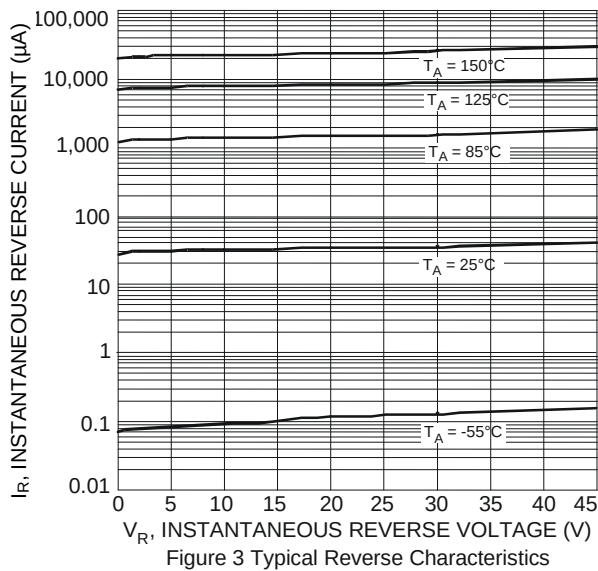
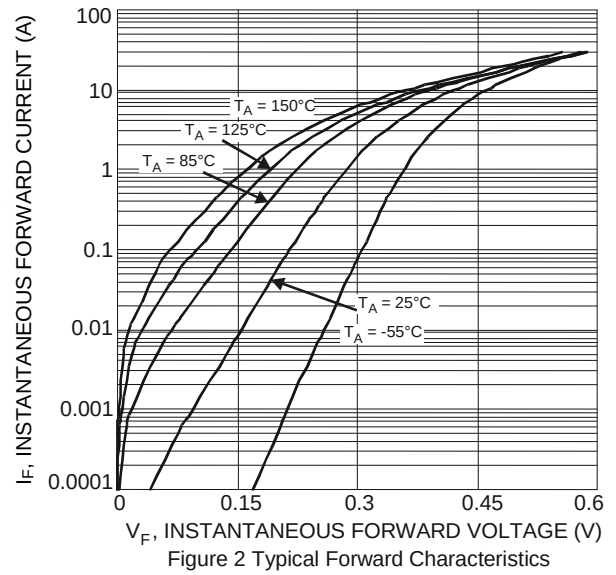
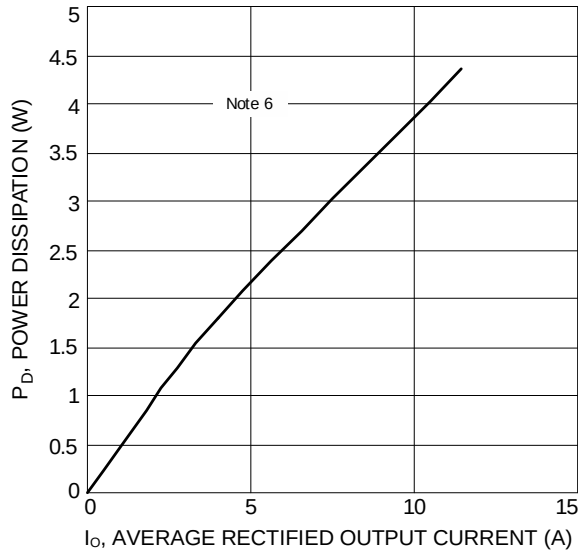
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	73	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	31	°C/W
Operating Temperature Range	V _R ≤ 80% V _{RRM}	-65 to +150	°C
	V _R ≤ 50% V _{RRM}	≤180	
	DC Forward Mode	≤200	
Storage Temperature Range	T _{STG}	-65 to +175	°C

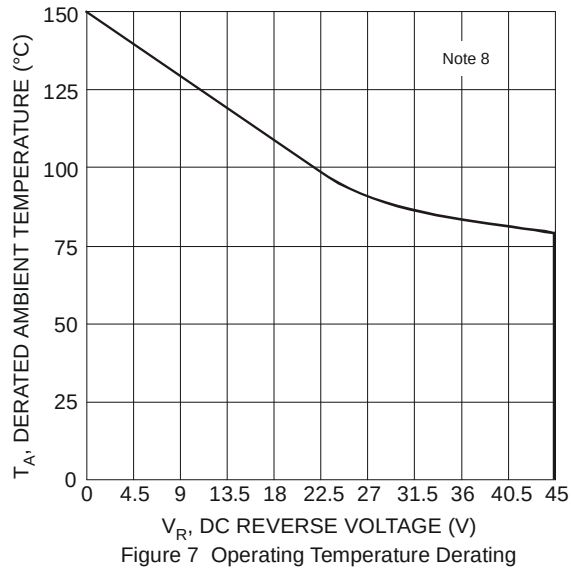
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	45	—	—	V	I _R = 0.3mA
Forward Voltage Drop	V _F	—	—	0.42	V	I _F = 8A, T _J = +25°C
		—	0.42	0.47		I _F = 10A, T _J = +25°C
		—	0.38	0.41		I _F = 10A, T _J = +125°C
Leakage Current (Note 7)	I _R	—	0.05	0.3	mA	V _R = 45V, T _J = +25°C
		—	—	15		V _R = 45V, T _J = +100°C
		—	28.0	75		V _R = 45V, T _J = +150°C

Notes: 5. FR-4 PCB, 2oz. Copper. Minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
6. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 14.4mm.
7. Short duration pulse test used to minimize self-heating effect.

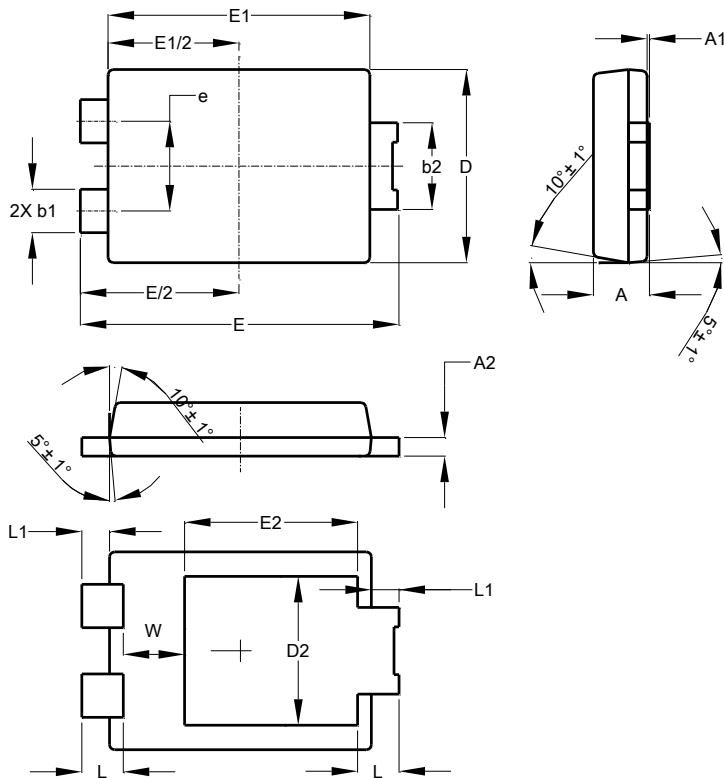


Notes: 8. Device mounted on FR-4 substrate, 2oz copper, with minimum recommended pad layout.
9. Device mounted on FR-4 substrate, 2oz copper, with 10cm x 10cm pad layout.



Package Outline Dimensions

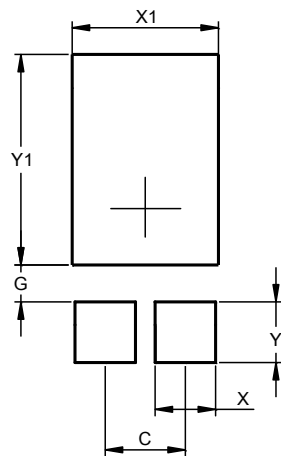
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.504
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860

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